

NOVASTACK® 35-HDH Connector

Part No. Plug:21003-0**E Receptacle:21004-0**E

Product Specification

Qualification Test Report No. TR-22021

0	S22310	July 8, 2022	M. Hidaka	S. Suzuki	Y. Hashimoto
Rev.	ECN	Date	Prepared by	Checked by	Approved by
Confidential C		I-PEX Inc.		QKE-DFFDE06-08 REV.12	

1. Scope

This Product Specification defines the test conditions and the performances of the NOVASTACK 35-HDH Connector, a board-to-board connector of 0.35 mm contact pitch.

2. Product Name and Parts No.

2.1 Product Name

NOVASTACK 35-HDH

2.2 Parts No.

Plug: 21003-0**E Receptacle: 21004-0**E

3. Rating

3.1 Operating Conditions

Amperage: Signal contact ... 0.5A AC/DC (per contact pin)

12.0A MAX. (total)

Voltage: 60V AC(r.m.s)/DC (per contact pin) Operating temperature: 233~358K(-40°C~+85°C) (Containing temperature rise by current) Operating humidity: 85%R.H. max.

3.2 Storage Conditions

Storage temperature: 248~333K(-25°C~+60°C) Storage humidity: 85%R.H. max. (Non-condensing)

4. Test and Performance

Test Condition

This initial test is equal to it's at shipping condition and unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

4.1. Electrical Performance

1. Contact resistance	
Reference standard:	MIL-STD-202-307
Test conditions:	Solder the receptacle connector to the test board and mate the plug connector together, then measure the contact resistance as shown in Fig. 1 by the four terminal methods. Apply the low level condition of 20mV MAX. DC for the open circuit voltage and 10mA DC for the closed circuit current.
	PLUG CONTACT (PLUG SIDE)
	CONTACT
	RECEPTACLE CONTACT
	Fig.1
Pass criteria:	<u>Signal contact</u> Initial: 50 mΩ max. After testing: ∠R 50 mΩ max. <u>Ground</u>
	Initial: 20 m Ω max. After testing: $\angle R20$ m Ω max.

2. Insulation resistance	
Reference standard:	MIL-STD-202G-302
Test conditions:	Mate the plug and receptacle connector together, and then apply DC 250 V between the neighboring contacts and
	contact to the shell.
Pass criteria:	Initial: 1,000 M Ω min. After testing: 500 M Ω min.

4.1. Electrical Performanc	ce de la constant de	
3. Dielectric withstanding voltage		
Reference standard:	MIL-STD-202-301	
Test conditions:	Mate the receptacle and plug connector together, then apply AC 250V(rms) between the neighboring contacts and contact to the shell for a minute.	
Pass criteria:	No abnormalities such as creeping discharge, flashover, insulator breakdown occur.	

4. Temperature rising	
Reference standard:	-
Test conditions:	Mate the plug and receptacle connector together and then apply rating current per contact.
	Pin contact 60P
	Signal contact • • • 0.5A/PIN.
	Total •••12A MAX.
Pass criteria:	Over ambient ∠T30 °C max.

4.2. Mechanical Performance

1. Mating force and Unmating force		
Reference standard:	-	
Test conditions:	Solder the plug and receptacle connector to the test board, then place the plug and receptacle on push-on/pull-off machine, measure of initial and mating/unmating 20 cycles at a speed 25±3 mm/min. along the mating axis.	
Pass criteria:	Mating force 60P: Initial 60 N MAX. Unmating force 60P: 20cycle 6.0 N MIN.	

2.Durability	
Reference standard:	-
Test conditions:	Solder the plug and receptacle connector to the test board, then place the board and plug on the push-on/pull-off machine, and repeat mating and unmating 20 cycles at a speed 25±3mm/min. along the mating axis.
Pass criteria:	Contact resistance: Shall meet4.1.1

3.Contact retention force	
Reference standard:	-
Test conditions:	Place the connector on the push-on/pull-off machine, then apply force on the contact head and push the contact along the direction opposite to the contact insertion at a speed of 25±3mm/min. Measure the force when the contact dislodges the connector.
Pass criteria:	Receptacle contact retention force: 0.1N MIN.

4.2. Mechanical Performance

4. Vibration	
Reference standard:	MIL-STD-202-201
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug connector, and place them on the vibrator. Then apply the following vibration. During the testing, run 100mA DC to check electrical discontinuity. Frequency: 10Hz→55Hz→10Hz/approx. 1 minute Directions: 3 mutually perpendicular direction. Total Amplitude: 1.52 mm Sweep duration: 2 hours for each direction, a total of 6 hours.
Pass criteria:	Contact resistance: Shall meet 4.1.1. Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur. Appearance: No abnormality adversely affecting the performance shall occur.

5. Shock		
Reference standard:	MIL-STD-202-213, Test condition A.	
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug connector, and place them on the shock machine. Then apply the following shock.	
	Max. G: 50G	Directions: 6 mutually perpendicular direction
	Duration: 11 msec	Cycle: 3 cycles about each direction
	Wave Form: Half Sinusoidal	
Pass criteria:	Contact resistance: Shall meet 4.1.1.	
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.	
	Appearance: No abnormality adversel	y affecting the performance shall occur.

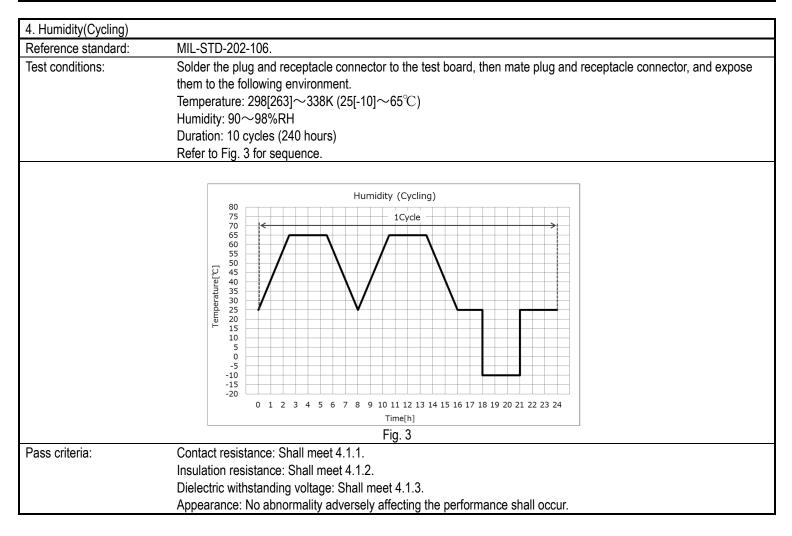
4.3. Environmental Performance

Reference standard:	MIL-STD-202-107, Test condition A.		
Test conditions:			
	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose		
	them to the following environment.		
	Temperature: 218K (-55°C), 30 minutes \rightarrow 358K (85°C), 30 minutes		
	Transition time: 5 minutes max.		
	No. of cycles: 5 cycles		
	Refer to Fig. 2 for sequence.		
	Thermal Shock		
	SCycle >		
	120 Cycle		
	100		
	-20		
	-40 -55℃60		
	-80 -80 Transition Time 5min. Max.		
	-100 0 30 60 90 120 150 180 210 240 270 300		
	Time[min]		
	Fig.2		
Pass criteria:	Contact resistance: Shall meet 4.1.1.		
	Insulation resistance: Shall meet 4.1.2.		
	Dielectric withstanding voltage: Shall meet 4.1.3.		
	Appearance: No abnormality adversely affecting the performance shall occur.		

2. High temperature life	
Reference standard:	MIL-STD-202-108, Test condition B.
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose them to the following environment. Temperature: 358±2K (85±2°C) Duration: 250 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Contact retention force: Shall meet 4.2.3. Appearance: No abnormality adversely affecting the performance shall occur.

4.3. Environmental Performance

3. Humidity (Steady state	
Reference standard:	MIL-STD-202-103, Test condition A.
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose them to the following environment. Temperature: 313±2K (40±2°C) Humidity: 90~95%RH Duration: 240 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur.



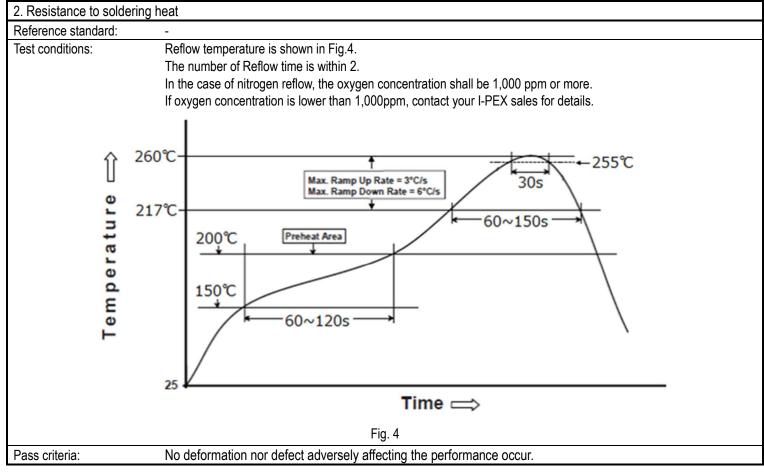
4.3. Environmental Performance

5. Salt water spray						
Reference standard:	MIL-STD-202-101, Test condition B.					
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose					
	them to the following environment.					
	Temperature: 308±2K (35±2°C)					
	Salt water density: 5±1% [by weight]					
	Duration: 48 hours					
Pass criteria:	Contact resistance: Shall meet 4.1.1.					
	Appearance: No abnormality adversely affecting the performance shall occur.					

6. H ₂ S gas								
Reference standard:	-							
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose							
	them to the following environment.							
	Temperature: 313±2K (40±2°C)							
	Relative humidity: 80±5%RH							
	Gas: H2S 3±1ppm							
	Duration: 48 hours							
Pass criteria:	Contact resistance: Shall meet 4.1.1.							
	Appearance: No abnormality adversely affecting the performance shall occur.							

4.4. Others

1. Solderability	
Reference standard:	MIL-STD-202G-208H
Test conditions:	Dip the solder tine of the contact in the solder bath at 518 \pm 5K (245 \pm 5 $^{\circ}$ C) for
	5±0.5 seconds after immersing the tine in the flux of RMA or R type for 5 to 10 seconds.
Pass criteria:	More than 95% of the dipped surface shall be evenly wet.



3. Soldering Iron		
Reference standard:	-	
Test conditions:	Operating temperature : $613\sim 633$ K (350° C ±10)	
	Application time of soldering iron : 5±1sec.	
	The number of times of application : 3times	
Pass criteria:	No deformation nor defect adversely affecting the performance occur.	

4.5 Test Sequence and Specimen Quantity

		Table	e 1 Test	t Sequenc	e and S	Sample	Quanti	ty					
Test Item	Group												
iest item	А	В	С	D	E	F	G	Н	J	Κ	L	М	Ν
Contact Resistance		2,6		1,3,5	1,5	1,3	1,5	1,5	1,3	1,3			
Insulation Resistance					2,6		2,6	2,6					
D. W. Voltage					3,7		3,7	3,7					
Temperature Rising	1												
Mating Force		1,5											
Unmating Force		3,7											
Durability		4											
Contact Retention Force			1										
Vibration				2									
Shock				4									
Thermal Shock					4								
High Temperature Life						2							
Humidity (Steady State)							4						
Humidity (Cycling)								4					
Salt Water Spray									2				
H2S Gas										2			
Solder Ability											1		
Soldering Heat Resistance												1	
Soldering Iron													1
Sample QTY.	5 pcs.	5 pcs.	20 pcs.	5 pcs.	10 pcs.	10 pcs.	10 pcs.						

Table 1 Test Sequence and Sample Quantity

XNumbers indicate sequence in which tests are performed.

5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension.